

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
DECAI LI	03/29/2021
YINGSONG LI	03/29/2021
XIAO LIU	03/29/2021
SIJIE REN	03/29/2021
PENGDONG HAN	03/29/2021
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<b>City:</b>	BEIJING
<b>State/Country:</b>	CHINA
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	17313391
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<b>DATE SIGNED:</b>	05/10/2021

**Total Attachments: 2**

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## ASSIGNMENT OF INVENTION

WHEREAS, we, **Decai LI**, Qinghuayuan, Haidian District, Beijing 100084, P. R. China; **Yingsong LI**, Qinghuayuan, Haidian District, Beijing 100084, P. R. China; **Xiao LIU**, Qinghuayuan, Haidian District, Beijing 100084, P. R. China; **Sijie REN**, Qinghuayuan, Haidian District, Beijing 100084, P. R. China, and **Pengdong HAN**, Qinghuayuan, Haidian District, Beijing 100084, P. R. China, have invented certain new and useful improvements in a **MAGNETIC LIQUID SEALING DEVICE**, for which an application for Letters Patent in the United States is being filed, claiming priority to Chinese Patent Application No. 202011598777.4 filed on December 29, 2020;

AND WHEREAS, **Tsinghua University**, Qinghuayuan, Haidian District, Beijing 100084, P. R. China, is desirous of acquiring all interest in said invention, said application, and in any Letters Patent which may be granted therefor;

AND WHEREAS, at the time the invention was made, we were under an obligation to assign all of our right, title, and interest in said invention to Tsinghua University.

NOW THIS INDENTURE WITNESSETH, that for the sum of one dollar and other valuable consideration to us in hand paid, the receipt of which is hereby acknowledged, we hereby assign, sell, and transfer unto said Tsinghua University our entire right, title, and interest in said invention, said application, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights, rights under the International Convention For The Protection Of Industrial Property, rights under the Patent Cooperation Treaty, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto.

And we hereby authorize and request the Commissioner of Patents and Trademarks to issue said United States Letters Patent to said Tsinghua University as the assignee of the whole right, title, and interest thereto.

And we further agree to sign and properly execute such necessary and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and for obtaining any reissue or reissues of any Letters Patent which may be granted for our aforesaid invention, as the assignee thereof shall hereafter require and prepare at its own expense.

WITNESS, our signature and date of execution:

Decai LI  
Decai LI

29 Mar. 2021  
Date

Yingsong LI  
Yingsong LI

29 Mar. 2021  
Date

Xiao LIU  
Xiao LIU

29 Mar. 2021  
Date

Sijie REN  
Sijie REN

29 Mar. 2021  
Date

Pengdong HAN  
Pengdong HAN

29 Mar. 2021  
Date